

PRODUCT DATASHEET

Glass Gas Discharge Tubes





Features

- RoHS compliant
- Bilateral symmetrical
- Less decay at on/off state
- Approximately zero leaking current before clamping voltage
- High capability to withstand repeated lightning strikes
- Low electrode capacotance(≤1.0pF) and high isolation(≥100MΩ)
- Temperature, humidity and lightness insensitive

Applications

- Satellite antenna
- Radio amplifiers
- Alarm systems
- Cathode ray tubes in Monitors/Television Viewing Systems

- Power Supplies
- Motor sparks absorbing
- Data line pulse guaeding
- Telephone/Fax/Modem
- High frequency signal transmitters/receivers

Electriacl Characteristics

Part No.	DC Spark-over Voltage V/s(V)	Impulse Spark-over Voltage (1KV/µs) Max.	Impulse Withstanding Voltage Capacity (10x700µs)KV	Impulse Discharge Current (8x20us)(kA)	Insulation Resistance Min.	Capacitanc e C Max.(pF)
JGS5026-140A	140±30%	650	2.0	1.0	100MΩ/50Vdc	1
JGS5026-200A	200±20%	700	2.0	1.0	100MΩ/100Vdc	1
JGS5026-300	300±20%	900	2.0	0.5	100MΩ/100Vdc	1
JGS5026-400	400±20%	-	2.0	0.5	100MΩ/250Vdc	1
JGS5026-500	500±20%	-	2.0	0.5	100MΩ/250Vdc	1
JGS5026-600	600±20%	-	2.0	0.5	100MΩ/250Vdc	1

Electrical Performance

Item	Testing condition and method	Performance
DC Spark-over	Measure starting discharge voltage (Vs) by gradualy increasing applied	Meet specified
Voltage(Vs)	DC voltage. Test current is 1mA max. and test period is 1 second max. and the DC voltage ascend up within 100v/second.	value
Insulation	Measure the insulation resistance(IR) across the terminal at regulated	100M Ω or over
Resistance(IR)	voltage 50V/100V/250V.	
Capacitance	Measure the electrostatic capacitance by applying a voltage of less than 6V (at 1MHz)between terminals.	1pF or less



Mechanical performance

Item	Testing condition and method	Performance
Lead wire pull strength	Gradually applying the load 0.5Kg and keeping the unit fixed for 10±1sec.	Meet DC spark-over voltage tolerance Not pull out and break the lead wire.
Lead wire bending Strength	The unit shall be secured with its lead wire kept vertical and the 0.25kg weight below be applied in the axial direction. The lead wire shall gradually be bend by 90 in one direction at the point of 3mm from the body along the radius of curvature (0.75mm~0.8mm), and again back the original position. The procedure shall be repeat 2 times for 30 sec.	Meet DC spark-over voltage tolerance.
Solderability	After dipping the lead wire to a depth of 2mm from the body in a soldering bath of 260 \pm 5 °C for 3 \pm 1 sec.	Over 95% of the lead wire should be covered with new solder.
Resistance to soldering heat	After dipping the lead wire to a depth of 2mm from the body in a soldering bath of 260±5 $^\circ$ C for 10±1 sec.	Meet DC spark-over voltage tolerance.

Environmental Characteristics

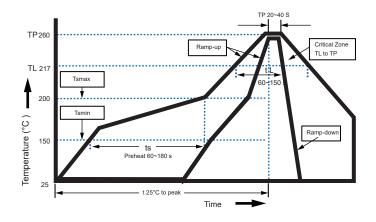
Item	Testing condition and method					Performance
Resistance to	The specimen shall be	subjected to	- 45±3℃ for	1000±4 hours	without load	Meet specified value.
cold	and then stored at roor	n temperature	e and humidit	y for 4 hours		
Resistance to	The specimen shall be	subjected to	125±2℃ for ′	1000±4 hours	without load	Meet specified value.
heat	and then stored at roor	n temperature	e and humidit	y for 4 hours		
Resistance to	The specimen shall be	subjected to	45±2℃ 90%-	95%R.H.for	1000±4 hours	Meet specified value.
humidity	without load and then					
Heat cycle	Repeat the temperature cycle shown below 10 times then store parts at room					m
	temperature and humidity for 4 hours.					
	Step	Step 1 2 3 4				
	Temperature	-45±3°C	Room Temp	125±2°C	Room Temp	
	Perild	30min	3min	30min	3min	
Temperature	Operating temp range :-55°C to +125°C					
range	Storage temp range :-40°C to +85°C					
	Storage life: 2year					



Surge life test

Item	Testing condition and method	Performance
Surge life	Charge a 1000pF capacitor up to DC 10kV and apply it to the sample. Do this 100 times at 10 seconds intervals.	
Surge life	Apply a impulse current (1.2/50µs & 8/20µs of 1kA/0.5kA)for ±5 times at 60s intervals, Thereafter, the characteristics of times Vs,IR and C shall be measured (EN61000-4-5).	No cracks or failures after applying current.
Surge life	Apply a impulse withstanding voltage capacity (10/700 μ s of 2kV/1kv 40 Ω) for ±5 times at 60 seconds intervals,Thereafter, the characteristics of times Vs,IR and C shall be measured(ITU K21).	No cracks or failures after applying current

Soldering Parameters



- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Recommended maximum paste thickness is 0.25mm Devices can be cleaned using standard industry methods and solvents.
- Note 1:All temperature refer to topside of the package, measured on the package body surface.
- Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

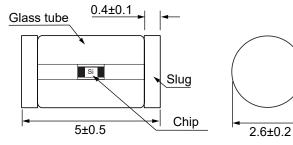
Profile Feature	Pb-Free Assembly			
	To-free Assembly			
Average Ramp-Up Rate	3°C/second mac.			
(Ts max to T p)				
Preheat				
-Temperature Min(Ts min)	150°C			
-Temperature Max(Ts max)	200°C			
-Time(Ts min to Ts max)	60~180 seconds			
Time maintained above:				
-Temperature(TL)	217°C			
-Time(tL)	60~150 seconds			
Peak Temperature(Tp)	260°C			
Ramp-Down Rate	6°C/second max.			
Time 25°C to Peak Temperatu	re 8 minutes max			
Storage And Handling:				
Storage conditions 0°C~ 35°C,30% ~60%R.H.				
Devices may not meet specified performance if storage				
conditions are exceeded.	, and the second			
Hand Soldering:				
Solder iron temperature:	0°C~350°C±5°C.			

Heating time: 3 seconds max.



Dimensions and Structure

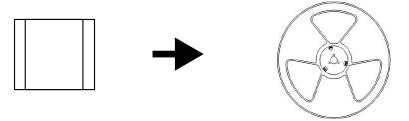
Unit: mm



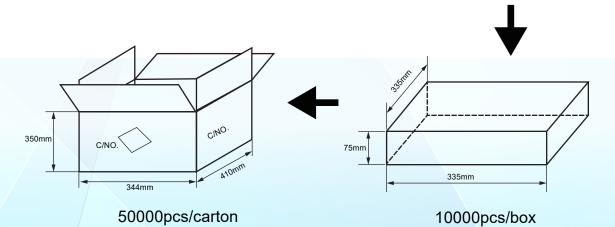
Item	Materials
Slug	90%OXY.DUMET Tail
Glass	Corning 8870 glass
Chip	Silicon

Packaging

No.	Quantity &Packaging Code
JGS5026	2500 pcs/reel

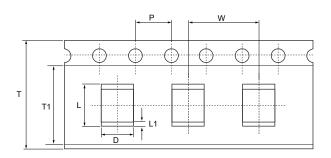


2500pcs/reel





Tape And Reel Specifications (mm)



Item	w	Т	L	P	D
Spec.(mm)	8.0±0.1	12.0±0.2	5.1±0.2	4.0±0.1	2.7±0.2

Part Number System

